FP6601AA

Type-A HVDCP Controller With Plug In/Out Auto Detection

Description

The FP6601AA is USB Type-A fast charging protocol controller with plug in/out auto detection for HiSilicon Fast Charging Protocol (FCP) and Qualcomm[®] Quick Charge[™] 2.0/3.0 (QC 2.0/3.0) USB interface. The FP6601AA monitors USB DPx/DNx data line and automatically adjusts the output voltage depending on different portable device requirement. The charging time of portable device is therefore optimized by the FP6601AA.

FP6601AA can support not only USB BC compliant devices, but also Apple / Samsung / HUAWEI devices and automatically detects whether a connected powered device is QC 2.0/3.0 or FCP capable before enabling output voltage adjustment. If a PD is not compliant with QC 2.0/3.0 and FCP, the FP6601AA will disable the adjustment of output voltage and keep the default 5V output voltage for safe operation.

Additionally, the FP6601AA also monitors automatically adjust the output voltage depending on different device requirement. It is capable providing output voltage of 3.6V to 12V.

P6 Package CPC-20L

Pin Assignments

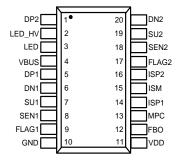


Figure 1. Pin Assignment of FP6601AA

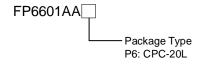
Features

- VDD Supply Voltage: 3.2V to 6.8V
- Supports HiSilicon Fast Charging Protocol (FCP)
- Supports Qualcomm[®] Quick Charge[™] 2.0/3.0 Class A
- Automatically Selects FCP and QC2.0/3.0 Protocols
- Supports USB DCP Shorting D+ Line to D- Line per USB Battery Charging Specification, Revision 1.2
- Supports USB DCP Applying 2.7V on D+ Line and 2.7V on D- Line
- USB Type-A Plug In/Out Detection
- Multi-Ports Control Application
- Over-Voltage Protection and VBUS Discharge Function
- Short-Circuit Protection
- Over-Current Protection
- LED Indicate Function
- UL Certification No. 4789032334-2

Applications

- Wall-Adapter
- Car Charger
- Power Strip
- USB Power Output Port

Ordering Information





Typical Application Circuit

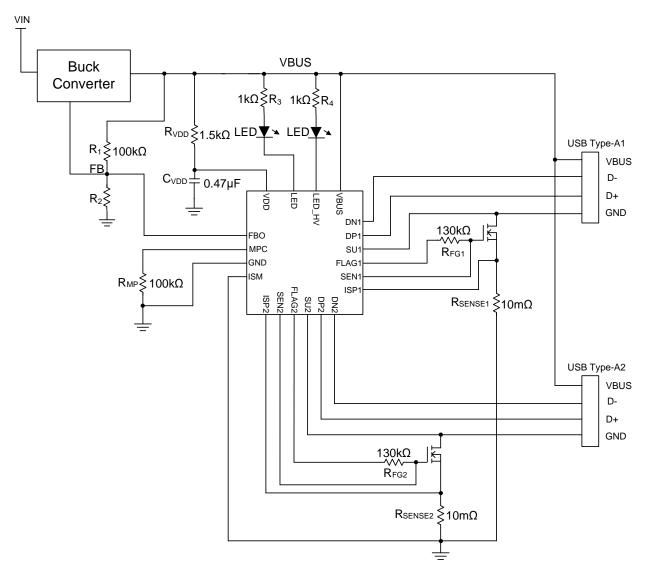


Figure 2. FP6601AA Typical Application Schematic



Functional Pin Description

Pin Name	Pin No.	Pin Function			
DP2	1	D+ data line of USB Type-A2. Recommended this pin connect without resistors(open) or with a resistor higher than $1M\Omega$ connect to GND.			
LED_HV	D_HV 2 Indicate Function. If FP6601AA into fast charging mode, the LED_HV will light.				
LED	LED 3 Indicate Function. If FP6601AA VBUS voltage states is 5V, the LED will light.				
VBUS	4	VBUS voltage detection and discharge.			
DP1	5	D+ data line of USB Type-A1. Recommended this pin connect without resistors(open) or with a resistor higher than $1M\Omega$ connect to GND.			
DN1	6	D- data line of USB Type-A1.			
SU1	7	Sense voltage of USB Type-A1 connecter plug in.			
SEN1	8	Detection function Pin. Detect USB Type-A1 whether is device existence.			
FLAG1	N-MOSFET gate node control. When USB Type-A1 plug in, FLAG1 will be activated high. Conversely, Type-A1 plug out, FLAG1 will be activated low.				
GND 10 Ground pin.		Ground pin.			
VDD	VDD 11 Power supply input pin.				
FBO	12	Output voltage control pin. Current sink function for FB node.			
MPC	13	Multi-ports control. Connect a 100kΩ resistor to GND.			
ISP1	ISP1 14 Positive input of current sense amplifier of USB Type-A1. Connect to the current sense resistance power path.				
ISM	Negative input of current sense amplifier of LISB Type-A1 and A2. Connect to the current sense resistor				
ISP2	SP2 Positive input of current sense amplifier of USB Type-A2. Connect to the current sense resistor on the VBL power path.				
FLAG2	AG2 N-MOSFET gate node control. When USB Type-A2 plug in, FLAGA2 will be activated high. Conversely, Type-A2 plug out, FLAG2 will be activated low.				
SEN2	18	B Detection function Pin. Detect USB Type-A2 whether is device existence.			
SU2	19	Sense voltage of USB Type-A2 connecter plug in.			
DN2	20	D- data line of USB Type-A2 port.			



FP6601AA

Absolute Maximum Ratings (Note 1)

Input Supply Voltage VDD	-0.3V to +7V
• FBO, FLAGX	-0.3V to +6.5V
• ISPx, ISM, MPC	-0.3V to +6.5V
• DPx, DNx	0.3V to +20V
• VBUS, SUx, SENx	-0.3V to +20V
• HV_LED, LED	0.3V to +20V
Maximum Junction Temperature (T _J)	- +150°C
Storage Temperature (T _S)	-65°C to +150°C
• Lead Temperature (Soldering, 10sec.)	- +260°C
 Package Thermal Resistance, (θ_{JA}) (Note 2) 	
CPC-20L	TBD
 Package Thermal Resistance, (θ_{JC}) 	
CPC-20L	TBD

Note 1: Stresses beyond this listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Note 2: θ_{JA} is measured at 25°C ambient with the component mounted on a high effective thermal conductivity test board of JEDEC-51-7.

Recommended Operating Conditions



Electrical Characteristics

(VDD=5V, T_A=25°C and the recommended supply voltage range, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input Power						ı
VDD Input Voltage Range	V _{DD}		3.2		6.8	V
Leave LING O. Thousand all	V_{DD_UVLO}	V _{DD} Rising	3.1	3.3	3.5	V
Input UVLO Threshold	V _{DD_HYS}	V _{DD} Falling	2.45	2.6	2.75	V
VDD Supply Current	I _{DD_SUP}	V _{DD} =5V, Nothing Attach	20	33	45	μА
VDD Shunt Voltage	V _{DD_SHUNT}		5.9	6.4	6.8	V
VBUS					1	
VBUS Over-Voltage Protection			14.25	15	15.75	V
VBUS Bleed Discharge Resistance	R _{Bleed}		8	10	12.5	kΩ
VBUS Discharge Resistance	R _{DIS}			400		Ω
USB Type-A		1			1	II.
A_Plug in SUx Threshold	V _{TH-USBAIN}		0.57	0.83	1.02	V
A_Plug in De-bounce Time	T _{USBAIN-DEB}			20		μs
A_Plug out SUx Threshold	V _{TH-USBAOUT}			80		mV
DPDN OV Threshold	V _{DPDNOV}			4		V
High Voltage Dedicated Charging	Port (HVDCP)		- 1		1	ı
Data Detect Voltage	V _{DAT(REF)}		0.25	0.325	0.4	V
Output Voltage Selection Reference	V _{SEL_REF}		1.8	2.0	2.2	V
DPx High Glitch Filter Time	T _{GLITCH(BC)-DPA_H}		1000	1250	1500	ms
DNx Low Glitch Filter Time	T _{GLITCH(BC)-DMA_L}			1		ms
Output Voltage Glitch Filter Time	T _{GLITCH(V)}		20	40	60	ms
DNx Pull-Down Resistance	R _{DMA(DWN)}			20		kΩ
Continuous Mode Glitch Filter Time	T _{GLITCH} -CONT-CHA		100		200	μs
DPx Leakage Resistance	R _{DAT-LKG}	V _{DD} =3.2 to 6.4V VDPA=0.6-3.6V Switch SW1=Off	300	500	800	kΩ
Switch SWx On-Resistance	R _{DS_ON_N1}	V _{DD} =5V,SW1= 200μA			40	Ω
UP/Down Current Step	I _{UP} , I _{DOWN}	I _{UP} = 0μA (5V),40μA (9V) 70μA (12V) I _{DOWN} = 14μA (3.6V)		2		μA

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Electrical Characteristics (Continued)

(VDD=5V, T_A=25°C and the recommended supply voltage range, unless otherwise specified.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
DCP Charging Mode						
DPx_0.48V / DNx_0.48V Line Output Voltage			0.44	0.48	0.52	V
DPx_0.48V / DNx_0.48V Line Output Impedance				900		kΩ
Apple Mode						
DPx_2.7V DNx_2.7V Line Output Voltage			2.57	2.7	2.84	V
DPx _{2.7V} / DNx _{2.7V} Line Output Impedance				33.6		kΩ
LED Indicate						
LED		Power Good, VBUS=5V		1		mA
LED_HV		Fast Charge Mode		1		mA
DNx SECTION (FCP)						
DNx FCP Tx Valid Output High	V _{TX-VOH}	2.55			3.6	٧
DNx FCP Tx Valid Output Low	V _{TX-VOL}				0.3	٧
DNx FCP Rx Valid Output High	V _{RX-VIH}		1.4		3.6	V
DNx FCP Rx Valid Output Low	V _{RX-VIL}				1.0	V
DNx Output Pull-Low Resistance	R _{PD}		400	500	600	Ω
Unit Interval for FCP PHY Communication	UI	F _{CLK} =125kHz	144	160	180	μs
Over-Current Protection						
Over-Current Threshold	ОСР	R_{sense} =10m Ω		4.2		Α
Short-Circuit Protection	1		1		1	
Short-Circuit Threshold	SCP	FLGAx pin turn on. Detection VBUS		3.6		V



Application Information

Function Description

The FP6601AA integrates both USB high voltage dedicated charging port interface IC for Qualcomm $^{\text{\tiny R}}$ Quick Charge $^{\text{\tiny TM}}$ 2.0/3.0 class A and HiSilicon FCP specification.

The FP6601AA can fast charge most of the handheld devices. It could be treated as the original charging adapter.

The FP6601AA supports BC1.2, Samsung and HUAWEI devices. It also supports output voltage range of C 3.0 Class A (3.6V to 12V) or QC 2.0 Class A (5V, 9V, 12V).

Quick Charge 2.0/3.0 Interface

When the FP6601AA is powered on, DPx and DNx pin are applied to 2.7V for Apple device. If handheld device has the function of QC 2.0/3.0, DPx pin will be forced between 0.325V and 2V. In the meanwhile, DPx pin will short to DNx pin through the switch SWx for entering BC 1.2. If DPA is continuously applied to the voltage between 0.325V and 2V for 1.25 seconds, the FP6601AA will enter QC 2.0/3.0 or FCP operation mode. The QC 2.0/3.0 could be classed as the following table.

D+	D-	Output Voltage		
0.6V	0.6V	12V		
3.3V	0.6V	9V		
0.6V	3.3V	Continuous mode		
0.6V	High-Z	5V (Default)		

When the voltage of DPx pin and DNx pin simultaneously satisfy these two inequalities $V_{\text{DAT(REF)}}$ < DPx <V $_{\text{SELREF}}$ and DNx > V $_{\text{SELREF}}$, the FP6601AA would enter continuous mode.

In the continuous mode, each voltage pulse on DPx pin generated by powered device is between 1V and 3V. In the meanwhile, the high level of pulse should be keep at least 200 μ s. If the specified conditions are satisfied, the FBO pin will sink 2uA per pulse. The maximum sink current is 70 μ A for output voltage 12V.

If the powered device doesn't support QC 2.0, the FP6601AA will remain default output voltage 5V for safe operation. On the other hand, when USB cable is removed, the voltage of DPx pin is therefore lower than $V_{\text{DAT}(\text{REF})}$ and the output default voltage 5V is also applied.

Shunt Regulator

The VDD of FP6601AA is supplied by the wide output voltage through the external resistor RVDD. The internal Zener-Diode is utilized to clamp the VDD at 6.4V. The recommended value of RVDD and CVDD are $1.5 \mathrm{k}\Omega$ and $0.47 \mu F$, respectively.

Multi-Ports Control

Use for single VBUS source and multi USB channel applications. Connect all MPC pins on different Fitipower USB ICs together and connect a $100k\Omega$ resistor to GND. FP6601AA will auto detect the attachments between all Fitipower USB ICs and will auto decide multi-ports operation is allowed or not.

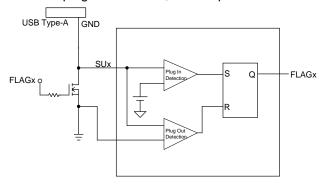
Data Line Protection

When DPx/DNx pin is touched by the external power in abnormal situation, the D+/D- pin of both sink device and source device may be damaged. In order to protect the DPx/DNx pin of the devices from damage in abnormal situation, the FP6601AA will return the output voltage to default output voltage 5V when the voltage of DPx/DNx pin is higher than 7.5V.

Plug in/out Auto Detection

When device plugs in or out, the FP6601AA can auto detect and into standby or operation mode:

- 1. Plug In detection is used for USB device plug in. When device plug in, FLAGx pin alerts active high.
- 2. Plug Out detection is used for USB device plug out. When plug out detected, FLAGx pin active low.





Application Information (Continued)

Over-Current Protection

The FP6601AA could detect the current value with current sense resistance(RSENSE=10m Ω) to support the Over-Current Protection(OCP). If out current over 4.2A, The FP6601AA will enable OCP function, then turn off N-MOSFET through FLAGx pin. Protection states is hiccup and auto recovery.

Short-Circuit Protection

The FP6601AA monitor VBUS voltage and FLAGx pin states to provide Short-Circuit Protection (SCP). When USB Type-A connect side occur short-circuit status (VBUS to GND), VBUS voltage will drop. If the voltage drop down to 3.6V and FLAGx pin turn on, The FP6601AA will enable SCP function, then turn off N-MOSFET through FLAGx pin. Protection states is hiccup and auto recovery.

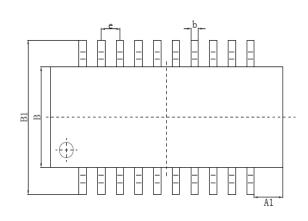
LED Indicate Function

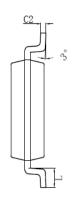
The FP6601AA provides two kinds of LED indication function that make it easy to know the IC's operating status. The FP6601AA VBUS voltage states is 5V, the LED pin will provide 1mA current to drive LED and LED_HV pin disable. Opposite, The FP6601AA into fast charging mode, the LED_HV will provide 1mA current to drive LED and LED pin disable.



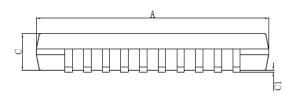
Outline Information

CPC-20L Package (Unit: mm)

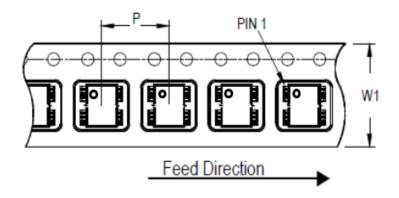


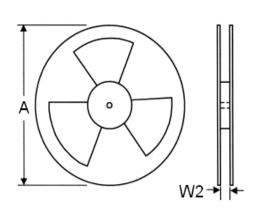


SYMBOLS	DIMENSION IN MILLIMETER				
UNIT	MIN	MAX			
Α	6.50	6.70			
A1	0.76	0.86			
В	2.50	2.70			
B1	3.85	4.15			
С	0.85	1.05			
C1	0.00	0.15			
C2	0.15	0.18			
е	0.53(BSC)				
b	0.16	0.26			
L	0.40	0.60			



Carrier Dimensions





Tape Size	Pocket Pitch	Reel Size (A)		Reel Width	Empty Cavity Length		
(W1)mm	(P)mm	(in)	(mm)	(W2)mm	(mm)	Units per Reel	
12	8	15	380	12.5	300~1000	6000	